

#	Layer	Thickness	Description	Dk	Df	Note
	Top Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
1	Top Side	0.035mm	Starting foil 1/2oz. after plating and processing			
		0.125mm	Prepreg IPC-4101/21	3,5	0,02	FR-4.0
2	Inner Layer 1	0.017mm	ED Base Copper			
		0.100mm	Core IPC-4101/21	3,5	0,02	FR-4.0
3	Inner Layer 2	0.017mm	ED Base Copper			
		0.125mm	Prepreg IPC-4101/21	3,5	0,02	FR-4.0
4	Inner Layer 3	0.017mm	ED Base Copper			
		0.100mm	Core IPC-4101/21	3,5	0,02	FR-4.0
5	Inner Layer 4	0.017mm	ED Base Copper			
		0.125mm	Prepreg IPC-4101/21	3,5	0,02	FR-4.0
6	Inner Layer 5	0.017mm	ED Base Copper			
		0.100mm	Core IPC-4101/21	3,5	0,02	FR-4.0
7	Inner Layer 6	0.017mm	ED Base Copper			
		0.125mm	Prepreg IPC-4101/21	3,5	0,02	FR-4.0
8	Bottom Side	0.035mm	Starting foil 1/2oz. after plating and processing			
	Bottom Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts

Total thickness: 1.002mm

notes: Final copper thickness according to IPC-6012 Please regard to our sectional design rules: ► www.we-online.com	BASIC8_ML8_1,00_17_V2.12		
	PCB Thickness Tolerance: ± 10%		
	customer		created
	pcb name		approved
	engineer		format
	date		
Template Revision: 02/2021 by Andreas Schilpp / Michael Kress / Werner Öchslen			

